

Appl. No. 10/565,044; Docket No. US03 0251 US2  
Amdt. dated August 18, 2006  
Response to Office Action dated June 16, 2006

### **REMARKS/ARGUMENTS**

Applicant appreciates Examiner's acknowledgement of allowable subject matter in claims 4, 5, 8, 9, and 13-16.

Claims 1-16 remain pending in the application.

In response to the Office Action's drawing objections, Applicant has amended the drawings and has supplied replacement sheets. A new drawing sheet 2 has been added. There are now six sheets of drawings. The changes are supported by the Specification and contain no new matter.

The disclosure has been amended to accommodate the amended drawings and in response to observations raised in the Office Action.

With respect to the Claims, the claims have been amended to overcome the objections and rejections under 35 U.S.C. §112. Language has been amended to replace term "an integrated circuit," with "semiconductor device die," to better clarify the claimed features. Likewise, terminology in the Specification has been amended to conform to these claim amendments.

Claims 1 and 12 have been cancelled. At the suggestion of the Office Action, Applicant has amended the allowable dependent claims into independent form. Claims previously dependent upon claim 1 have been amended to depend upon amended independent claim 4.

With these claim amendments, the rejections raised under §102 and §103 are now moot.

Claims 2-11 and 13-16 are now allowable.

Applicant believes he has addressed all of the Examiner's concerns. A timely Notice of Allowance is earnestly requested.

Please charge any fees other than the issue fee and credit any overpayments to Deposit Account 14-1270.

Respectfully submitted,

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